Preliminary

High Power LED Series 3535

LH351H 2W 660nm Deep Red Ver.3

For Horticulture Lighting



Features & Benefits

- Package : 2pad design with Al₂O₃
- Dimension : 3.5 mm X 3.5 mm
- Maximum current : 1.0 A
- Technology : AlGaInP



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1. Characteristics

a) Absolute Maximum Rating

ltem	Symbol	Rating	Unit	Condition
Ambient / Operating Temperature	Ta	-40 ~ +105	°C	Note 1)*
Storage Temperature	T _{stg}	-40 ~ +105	٥C	-
LED Junction Temperature	Tj	125	٥C	-
Forward Current (T _j : 25 ºC)	l _F	1000	mA	Note 2)*-
Reverse Voltage ((@ 10 mA)	Vr	1.1	V	-
Assembly Process Temperature		280 <10	°C s	-
ESD (HBM)	-	±8	kV	-

Notes:

1) Refer to the derating curve, '3. Typical Characteristics Graph', for proper driving current that maintained below maximum junction temperature.

2) Unpredictable performance may be resulted by driving the product at above Max. IF. But there will be no damage to the product.

b) Electro-optical Characteristics

ltem	Unit	Conc	lition	Value (tup.)
item	Onic	I _F (mA)	T _j (°C)	Value (typ.)
Radiant Power (Φ_E)	mW	700	25	1035
Photosynthetic Photon Flux (PPF) *	µmol/s	700	25	5.65
Forward Voltage (V _F)	V	700	25	2.07
Thermal Resistance (junction to solder point)	°C/W	700	25	3.0
Beam Angle	0	700	25	130
Peak wavelength (λ_p)	nm	700	25	660
Dominant wavelength (λ_D)	nm	700	25	638

Notes:

1) Samsung maintains measurement tolerance of: Radiant Power = ± 7 %, forward voltage = ± 0.1 V, Wavelength = ± 2 nm

2) Characteristics @ 25 °C are for reference only

3) Calculated PPF value is for reference only

2. Product Code Information

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18
S																	

Digit	PKG Information	Code	Specification
1 2 3	Samsung Package High Power	SPH	
4 5	Color	RD	Red
6	Product Version	3	
78	Product	L3	LH351 Series
9	Lens Type	D	Dome lens
10	Internal Code	н	
11	Wattage	2	2W
12	Sorting Temperature	0	25 °C
13 14	Forward Voltage (V)	C5	1.8 ~ 2.3V
15 16	Wavelength (nm)	W4	650 ~ 670
17 18	Radiant Power (mW)	3B	995 ~ 1120

a) Voltage Bins ($I_F = 700 \text{ mA}, T_j = 25 \text{ }^{\circ}\text{C}$)

Product Code	Voltage Rank	Voltage Bin	Voltage Range (V)
	<u>CE</u>	EA	1.8 ~ 2.05
SPHRD3L3DH20C5W43B	C5	EB	2.05 ~ 2.3

b) Wavelength Bins ($I_F = 700 \text{ mA}, T_j = 25 \text{ }^{\circ}\text{C}$)

Product Code	Wavelength Rank	Wavelength Bin	Wavelength Range (nm)
SPHRD3L3DH20C5W43B	W4	W4	650 ~ 670

c) Radiant Power Bins ($I_F = 700 \text{ mA}, T_j = 25 \text{ }^{\circ}\text{C}$)

Product Code	Power Rank	Power Bin	Power Range (mW)
		10	995 ~ 1030
SPHRD3L3DH20C5W43B	3B	20	1030 ~ 1060
3PRKD3L3DR20C3W43B	зв	30	1060 ~ 1090
		40	1090 ~ 1120

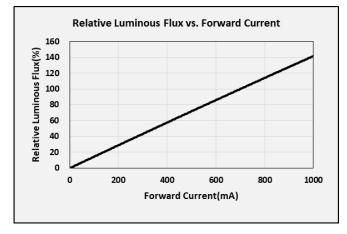
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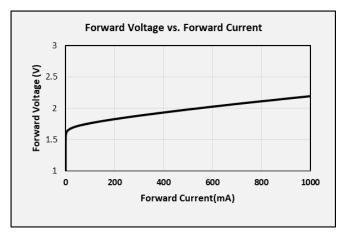
3. Typical Characteristics Graphs

Relative Intensity vs. Wavelength

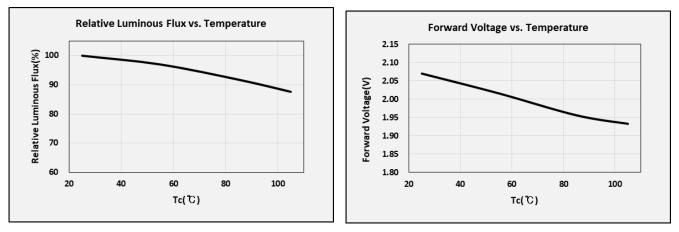
a) Spectrum Distribution (I_F = 700 mA, T_j = 25 °C)

b) Forward Current Characteristics (T_j = 25 °C)

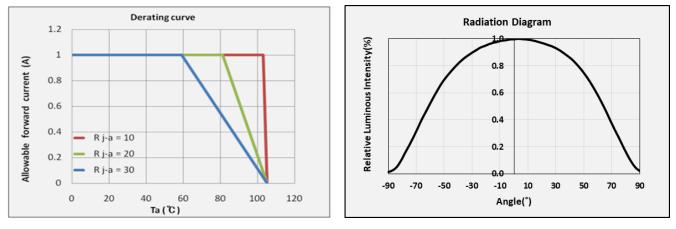




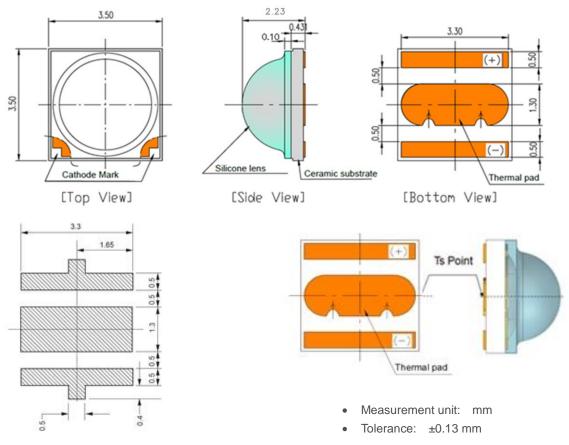
c) Temperature Characteristics ($I_F = 700 \text{ mA}$)







4. Outline Drawing & Dimension



Recommended Soldering Pattern

Notes:

- 1) This LED has built-in ESD protection device(s) connected in parallel to LED chip(s).
- 2) The thermal pad is electrically isolated from the anode and cathode contact pads.
- 3) T_s point and measurement method:
 - (1) Measure the nearest point to thermal pad as shown above. If necessary, remove PSR of PCB to reach Ts point.
 - 2 All pads must be soldered to the PCB to dissipate heat properly, otherwise the LED can be damaged.

Precautions:

- Pressure on the LEDs will influence to the reliability of the LEDs. Precautions should be taken to avoid strong pressure on the LEDs. Do not put stress on the LEDs during heating.
- 2) Re-soldering should not be done after the LEDs have been soldered. If re-soldering is unavoidable, LED's characteristics should be carefully checked before and after such repair.
- Do not stack assembled PCBs together. Since materials of LEDs is soft, abrasion between two PCB assembled with LED might cause catastrophic failure of the LEDs.

5. Reliability Test Items & Conditions

a) Test Items

Test Item	Test Condition	Test Hour / Cycle
High Temperature Life Test	85 °C, Maximum Rated Drive Current	1000 h
High Temperature Humidity Life Test	85 °C, 85 % R.H., Maximum Rated Drive Current	1000 h
Low Temperature Life Test	-40 °C, Maximum Rated Drive Current	1000 h
Temperature Cycling	-45 °C / 15 min ↔ 125 °C / 15 min temperature change within 5 min	500 cycles
High Temperature Storage	105 °C	1000 h
High Temperature Humidity Storage	85 ºC, 85 % R.H	1000 h
ESD (HBM)	$\begin{array}{c c} \mathbf{R}_{1} & \mathbf{R}_{2} \\ \mathbf{P}_{1} & \mathbf{P}_{2} \\ \mathbf{P}_{2} & \mathbf{P}_{1} \\ \mathbf{P}_{2} & \mathbf{P}_{2} \\ \mathbf{P}_{2} & $	5 times

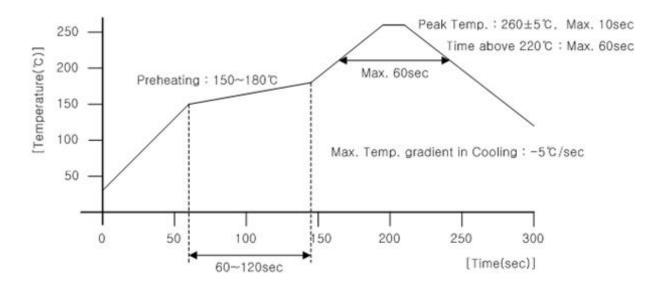
b) Criteria for Judging the Damage

ltem	Symbol	Test Condition	Lin	nit
nem	Symbol	(T _j = 25 ^o C)	Min.	Max.
Forward Voltage	VF	I _F = 700 mA	Init. Value * 0.9	Init. Value * 1.1
Luminous Flux	Φν	I _F = 700 mA	Init. Value * 0.7	Init. Value * 1.1

6. Soldering Conditions

a) Reflow Conditions (Pb free)

Reflow frequency: 2 times max.



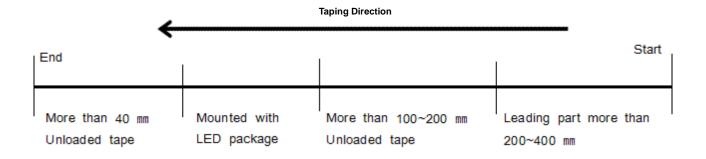
b) Manual Soldering Conditions

Not more than 5 seconds @ max. 300 °C, under soldering iron.

7. Tape & Reel

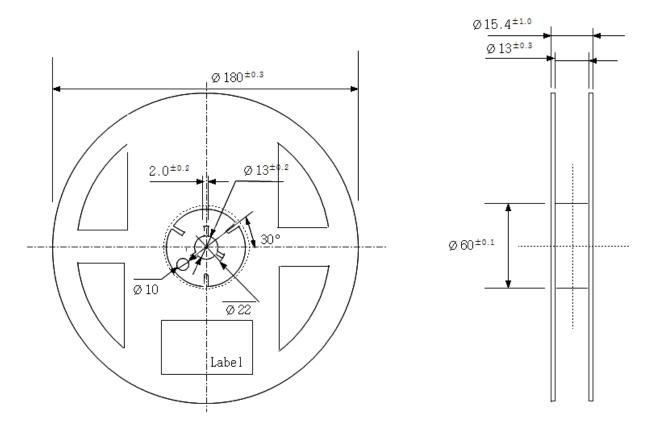
a) Taping Dimension

(unit: mm)





(unit: mm)

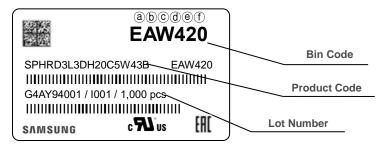


Notes:

- 1) Quantity: The quantity/reel is 1,000 pcs
- 2) Cumulative tolerance: Cumulative tolerance / 10 pitches is ±0.2 mm
- Adhesion strength of cover tape: Adhesion strength is 0.1-0.7 N when the cover tape is turned off from the carrier tape at 10° angle to the carrier tape
- 4) Packaging: P/N, Manufacturing data code no. and quantity are indicated on the aluminum packing bag

8. Label Structure

a) Label Structure



Note: Denoted bin code and product code above is only an example (see description on page 4)

Bin Code:

- (a)(b): Forward Voltage bin (refer to page 5)
- ©d: Wavelength bin (refer to page 5)
- (e)(f): Radiant Power bin (refer to page 5)

b) Lot Number

The lot number is composed of the following characters:

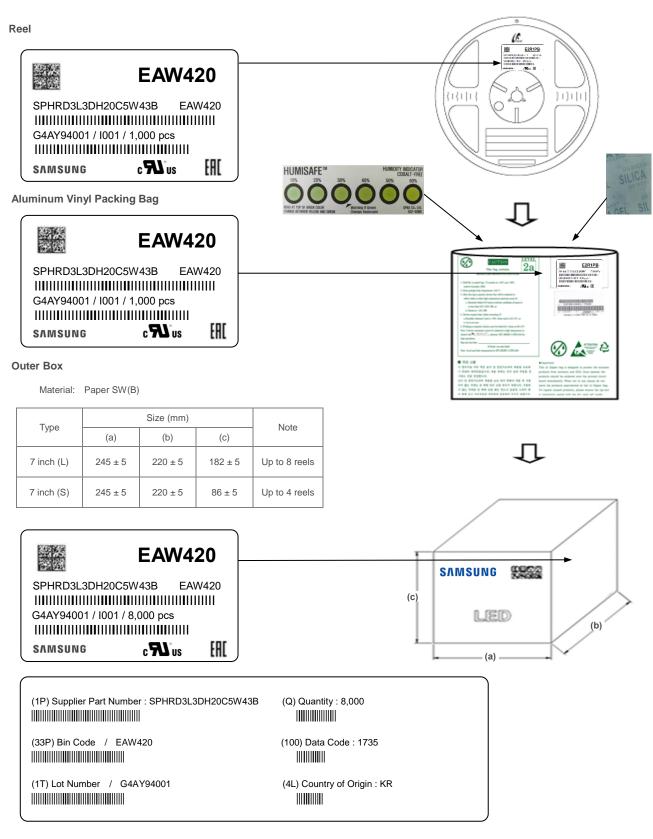
	EA	W420
SPHRD3L3DH200		
12345678	9/I@bc)/ 1,000 pcs
	LR 2	

123456789/Iabc /1,000 pcs

- (1), (2) : Production site (G4 : Guangzhou , China)
- ③ : Product state (A: Normal, B: Bulk, C: First Production, R: Reproduction, S: Sample)
- (4) : Year (D: 2019, E: 2020, F:2021 ...)
- (5) : Month (1~9, A, B, C)
- 6 : Day (1~9, A, B~V)
- (7)(8)(9) : Product serial number (001 ~ 999)
- (a)(b)(c) : Reel number (001 ~ 999)

9. Packing Structure

a) Packing Process



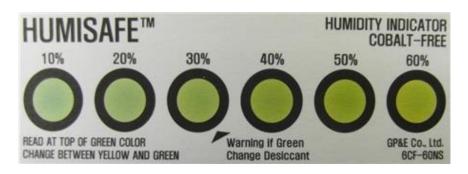
b) Aluminum Vinyl Packing Bag



b) Silica Gel & Humidity Indicator Card inside Aluminum Vinyl Bag

(This image is for reference only. Silicagel and humidity indicator shapes may be different.)







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10. Precautions in Handling & Use

- 1) For over-current protection, users are recommended to apply resistors connected in series with the LEDs to mitigate sudden change of the forward current caused by shift of forward voltage.
- 2) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When cleaning is required, IPA is recommended as the cleaning agent. Some solvent-based cleaning agent may damage the silicone resins used in the device.
- 3) When the device is in operation, the forward current should be carefully determined considering the maximum ambient temperature and corresponding junction temperature.
- 4) LEDs must be stored in a clean environment. Shelf life of sealed bags is 12 months at temperature 0~40 °C, 0~90 % RH.
- After storage bag is opened, device subjected to soldering, solder reflow, or other high temperature processes must be:
 a. Mounted within 672 hours (28 days) at an assembly line with a condition of no more than 30 °C / 60 % RH, or
 b. Stored at <10 % RH
- 6) Repack unused devices with anti-moisture packing, fold to close any opening and then store in a dry place.
- 7) Devices require baking before mounting, if humidity card reading is >60 % at 23 ± 5 °C.
- 8) Devices must be baked for 1 hour at 60 ± 5 °C, if baking is required.
- 9) The LEDs are sensitive to the static electricity and surge current. It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs. If voltage exceeding the absolute maximum rating is applied to LEDs, it may cause damage or even destruction to LED devices. Damaged LEDs may show some unusual characteristics such as increase in leakage current, lowered turn-on voltage, or abnormal lighting of LEDs at low current.
- 10) VOCs (Volatile Organic Compounds) can be generated from adhesives, flux, hardener or organic additives used in luminaires (fixtures). Transparent LED silicone encapsulant is permeable to those chemicals and they may lead to a discoloration of encapsulant when they exposed to heat or light. This phenomenon can cause a significant loss of light emitted (output) from the luminaires. In order to prevent these problems, we recommend users to know the physical properties of materials used in luminaires and they must be carefully selected.

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